



# Product Change Notification

**Change Notification #:** 118601-00  
**Change Title:** Intel® RAID Module RMSP3HD080E,  
PCN 118601-00, Product Design,  
Update firmware and CPLD code  
**Date of Publication:** October 19, 2021

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *</b>	November 03, 2021
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

1. Update the firmware to version 5.080.00-2758 (MR 7.8p1 on firmware package 50.8.0-2857).
2. Update the CPLD code to version 05656-012.

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® RAID Module RMSP3HD080E, 5 Pack	RMSP3HD080E	954553	J32824-005	J32825-203	J32824-006	J32825-204

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
October 19, 2021	00	Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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